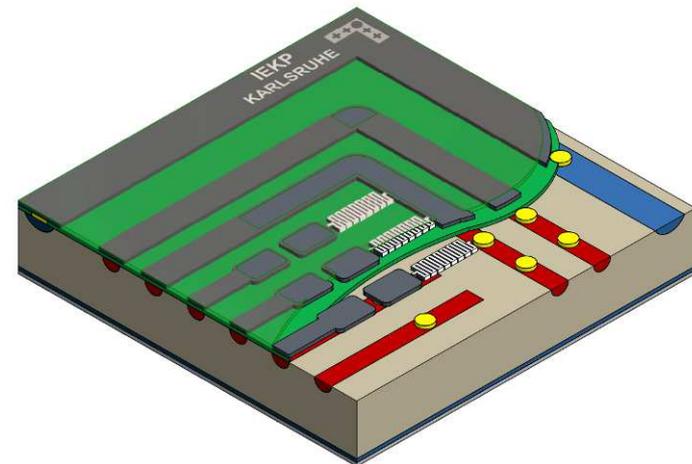
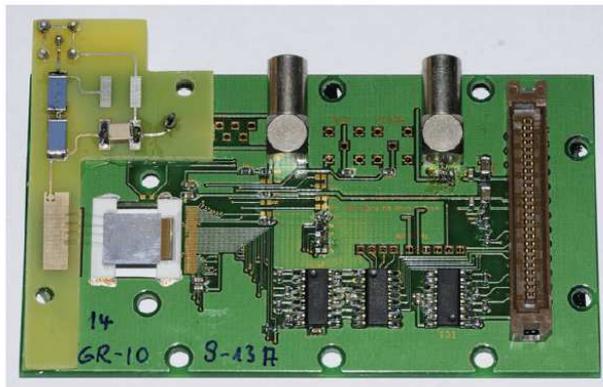


WP3.1: Bestrahlungen und Charakterisierung von Auslesekomponenten und Detektorelementen

Felix Bögelspacher, Alexander Dierlamm, Thomas Müller

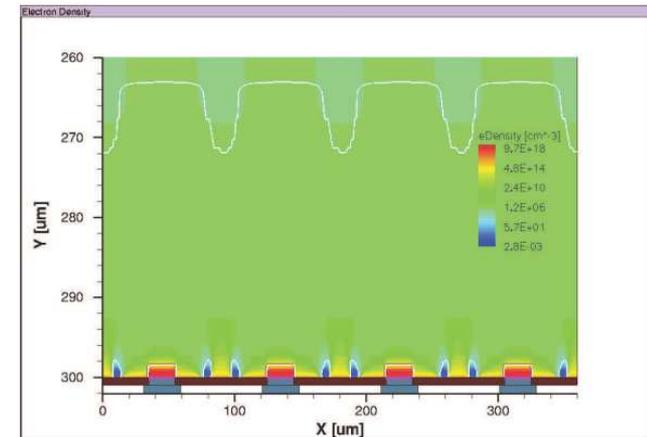
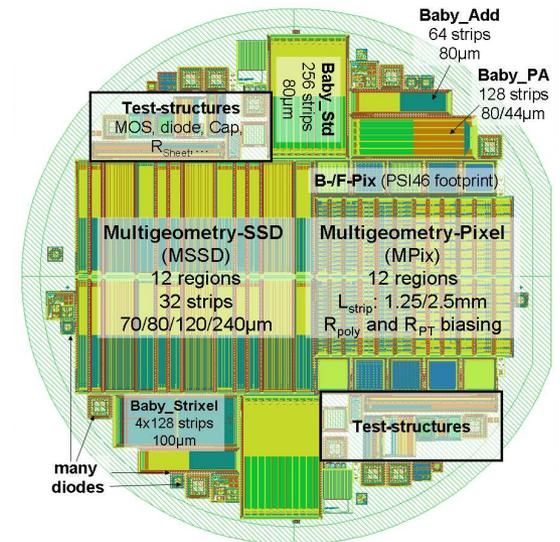
INSTITUT FÜR EXPERIMENTELLE KERNPHYSIK



Workpackage 3.1

- Title: **Bestrahlungen und Charakterisierung von Auslesekomponenten und Detektorelementen**
- Participating institute and group leader: Karlsruhe (Th. Müller)
- In this working package we continue the research on radiation hard detector elements. The funding allows us to employ a technician who performs the irradiations and to cover irradiation costs for institutes within the HHA.
- Main interest is the radiation hardness of silicon sensors, but also other components like optical fibers to measure environmental parameters or ASICs have been investigated.

- A total of 4.5h irradiation time
 - Preparation of a large irradiation campaign within CMS. Irradiation of samples for cross-calibration of the participating institutes.
 - Investigation of energy loss and increase in radiation damage in several layers of silicon. Three layers of 300 μm thick silicon are possible within an increase in damage of 15%.
- The understanding of the measurements of irradiated structures is assisted by **device simulations**. With the funding of this WP we were able to acquire a good simulation server with large memory and several cores.



- Total of 120h X-ray irradiations for HLL Munich
- Total of 15h proton irradiations for several groups
- Papers resulting from irradiations within this WP:
 - M. Köhler, R. Bates, G.-F. Dalla Betta, C. Fleta, J. Härkönen, K. Jakobs, M. Lozano, et al.
„Measurements with Irradiated 3D Silicon Strip Detectors“
Nuclear Physics B - Proceedings Supplements 215, Nr. 1 (June 2011): 247–249
 - A. Macchiolo, L. Andricsek, M. Beimforde, H.-G. Moser, R. Nisius, R.H. Richter, und P. Weigell
„Performance of thin pixel sensors irradiated up to a fluence of and development of a new interconnection technology for the upgrade of the ATLAS pixel system“
NIM A 650, Nr. 1 (Sep 2011): 145–149
 - U. Parzefall, et al.
„Silicon detectors for the sLHC“
NIM A 658, Nr. 1 (Dec 2011): 11–16
 - M. Köhler, R. Bates, C. Fleta, K. Jakobs, M. Lozano, Ch. Parkes, U. Parzefall, G. Pellegrini, and J. Preiss
„Comparative measurements of highly irradiated n-in-p and p-in-n 3D silicon strip detectors“
NIM A 659, Nr. 1 (Dec 11, 2011): 272–281
 - P. Weigell, M. Beimforde, Ch. Gallrapp, A. La Rosa, A. Macchiolo, R. Nisius, H. Pernegger, and R.H. Richter
„Characterization and performance of silicon n-in-p pixel detectors for the ATLAS upgrades“
NIM A 658, Nr. 1 (Dec 2011): 36–40
 - C. Gallrapp, A. La Rosa, A. Macchiolo, R. Nisius, H. Pernegger, R.H. Richter, and P. Weigell
„Performance of novel silicon n-in-p planar pixel sensors“
NIM A 679, Nr. 0 (July 2012): 29–35
 - J.-W. Tsung, M. Havranek, F. Hügging, H. Kagan, H. Krüger, and N. Wermes
„Signal and noise of diamond pixel detectors at high radiation fluences“
Journal of Instrumentation 7, Nr. 09 (Sep 2012): P09009–P09009

Characterization and performance of silicon n-in-p pixel detectors for the ATLAS upgrades

and

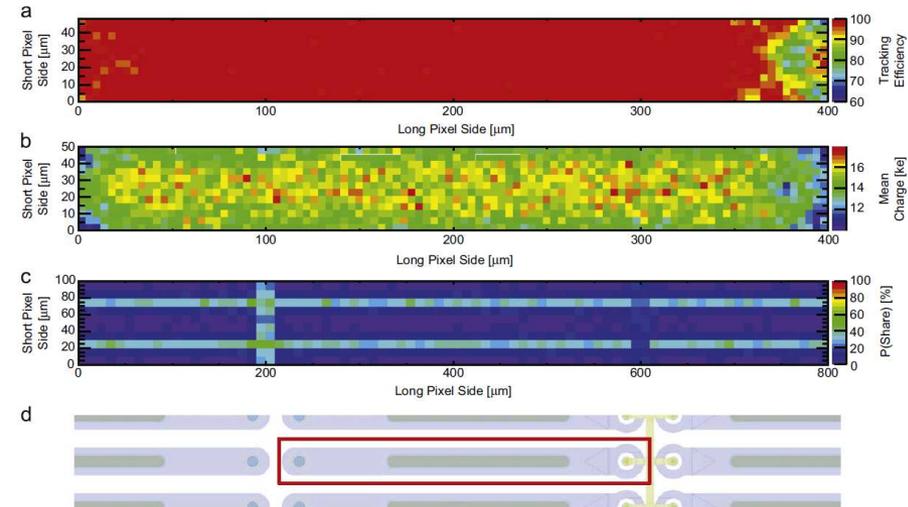
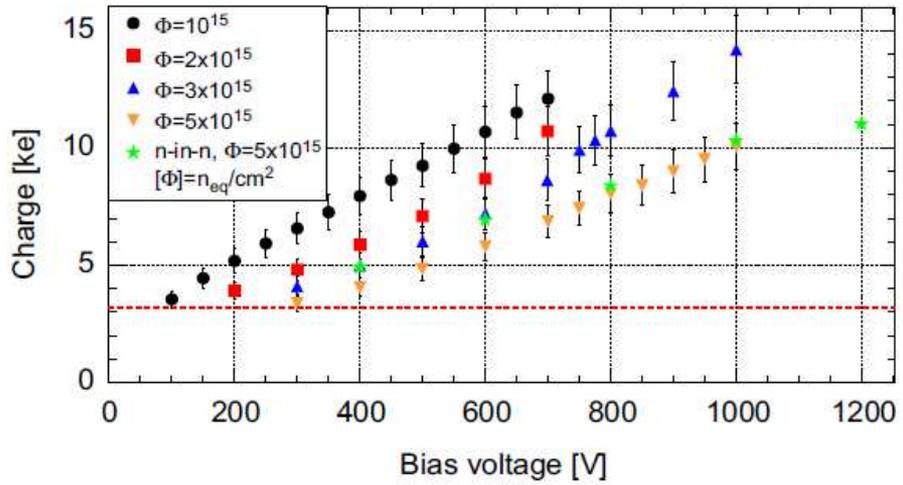
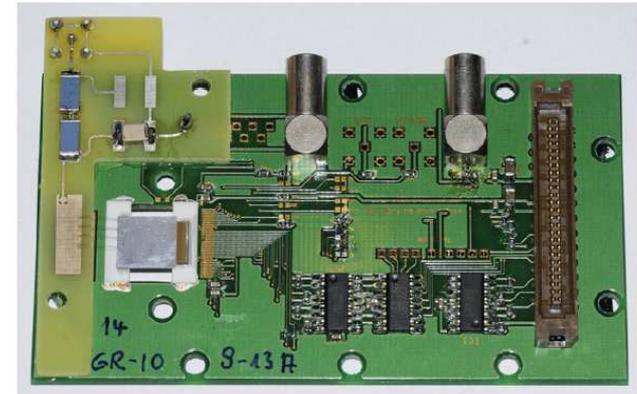
Performance of novel silicon n-in-p planar pixel sensors

■ P. Weigell, A. Macchiolo (Munich)

■ From conclusions:

- The stable operation at 700V for several days indicates that the risk of sparks is low if Benzo-Cyclo-Butene is applied.
- At $5 \cdot 10^{15} n_{eq} cm^{-2}$:
 - Signal over threshold of more than three, together with low noise, has been obtained
 - The tracking efficiency is $(98.6 \pm 0.3)\%$ with threshold of 3200 e, and biasing at 600 V.

NIM A 658 (2011): 36–40
NIM A 679 (2012): 29–35



Performance of thin pixel sensors irradiated up to a fluence of $10^{16}n_{eq}/cm^2$ and development of a new interconnection technology for the upgrade of the ATLAS pixel system

■ A. Macchiolo, P. Weigell (Munich)

■ From conclusions:

- A first production of n-in-p pixel sensors with an active thickness of 75 and 150 μm has been completed in view of the ATLAS pixel detector upgrades.
- CCE measurements performed after irradiation show that it is possible to recover 100% of the charge obtained before irradiation in the 75 mm thick sensors at a fluence of $10^{16}n_{eq}/cm^2$

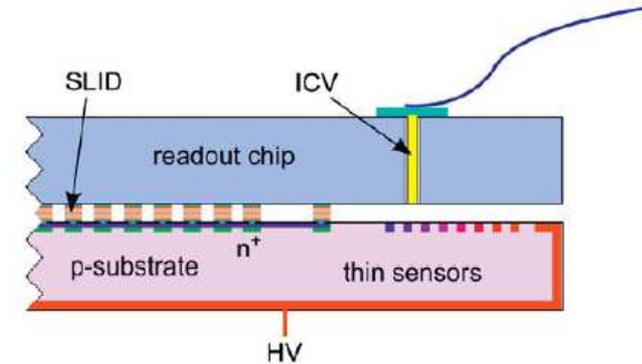
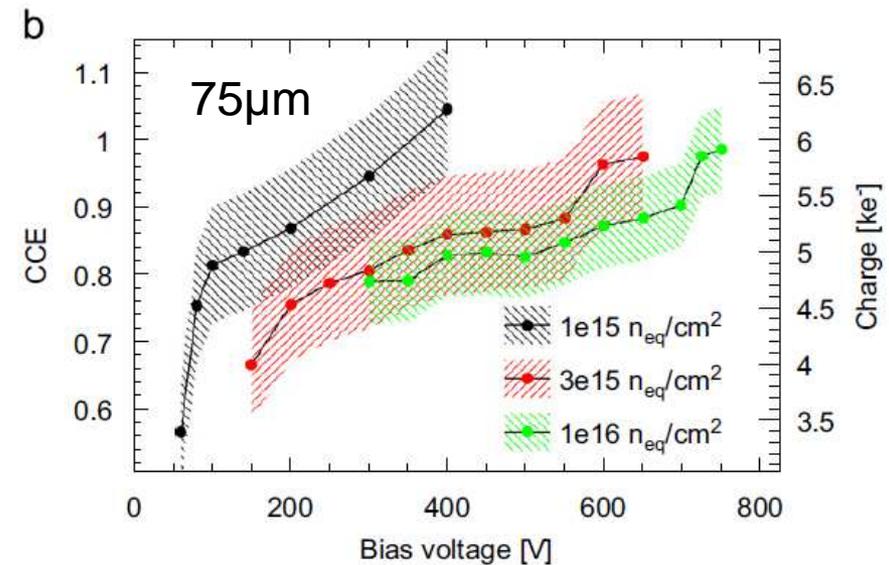
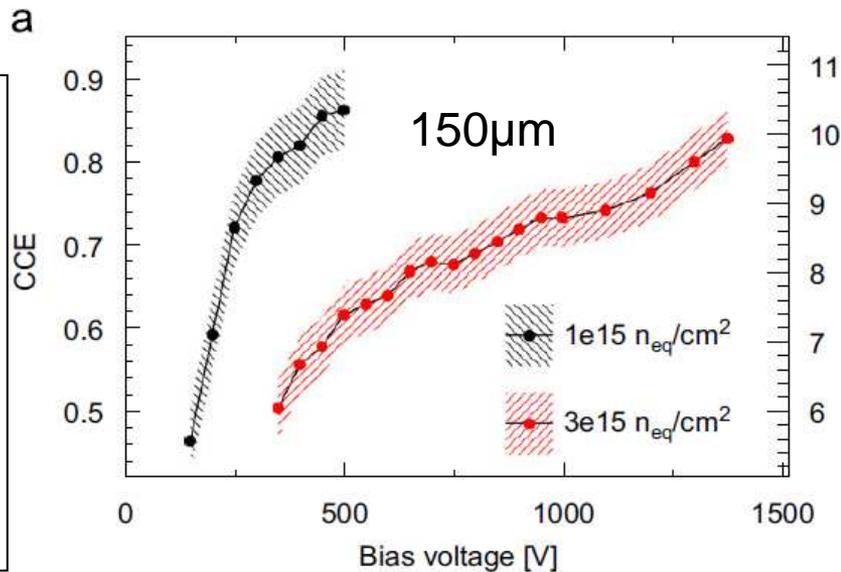


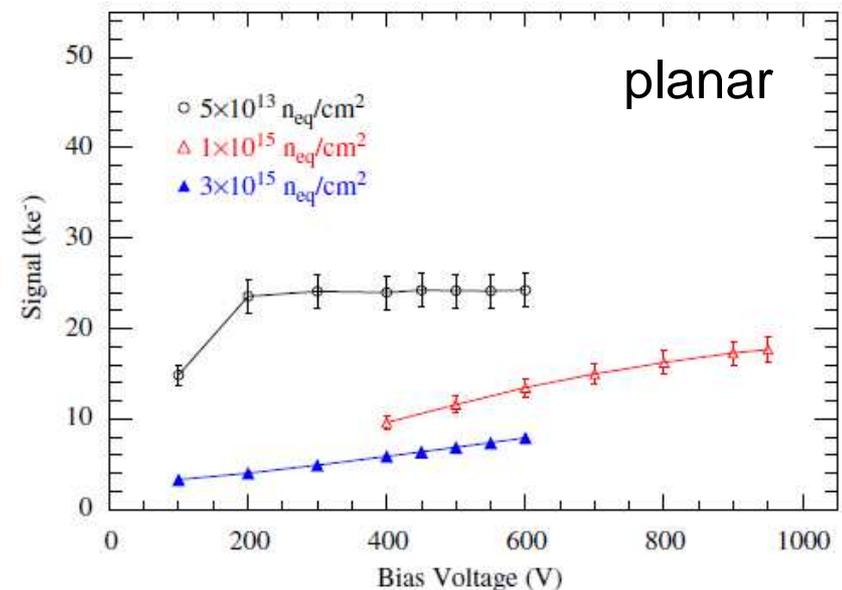
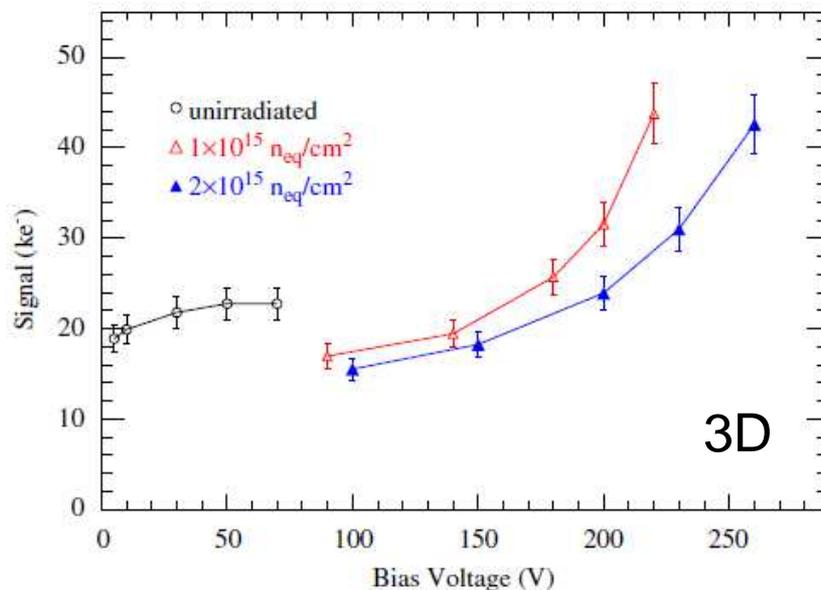
Illustration of the module concept, with the Solid Liquid Interdiffusion (SLID) as an alternative to the bump-bonding interconnection

NIM A 650 (2011): 145–149



Silicon detectors for the sLHC

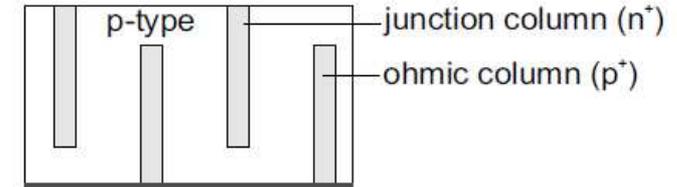
- U. Parzefall (Freiburg) for RD50
- From conclusions:
 - Several studies show that p-type planar silicon detectors have sufficient radiation hardness to be operated up to fluences in the order of a few $10^{15} \text{ n}_{\text{eq}}\text{cm}^{-2}$, provided that a sufficiently high bias voltage can be supplied.
 - 3D detectors would be able to offer a comparable radiation hardness at significantly lower bias voltages.



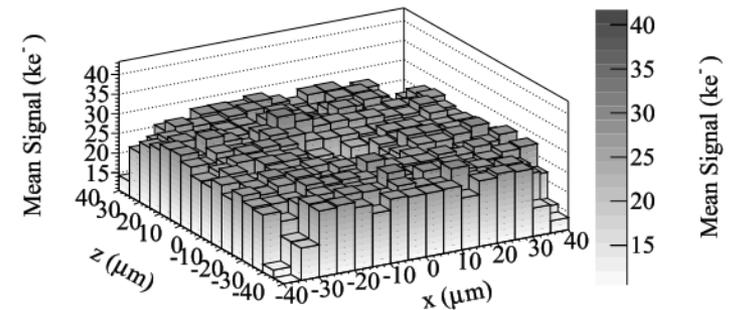
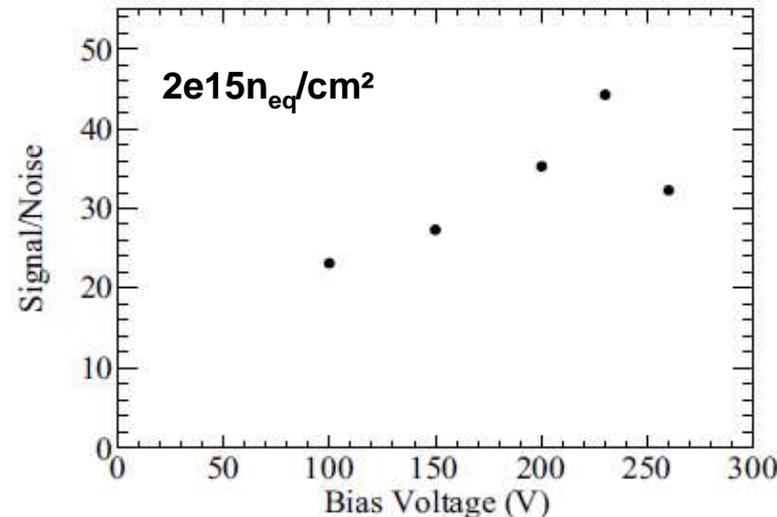
Measurements with Irradiated 3D Silicon Strip Detectors

- M. Köhler, U. Parzefall (Freiburg)
- From text:
 - The MPV measured at 230 V (after $2e15n_{eq}/cm^2$) is $31000e^-$. This observation indicates that the electric field, increased by radiation induced defects, is sufficiently high to cause charge multiplication due to impact ionisation.
 - The signal measured with the irradiated detector is less uniform, larger signals are measured for tracks impinging close to the junction column.

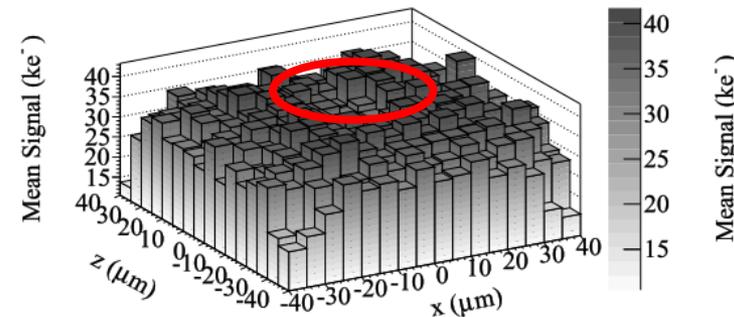
Nucl. Phys. B – Proc. Suppl. 215, (2011): 247–249



Cross-section of double-sided 3D p-type detector



(a) Unirradiated detector, 70 V.

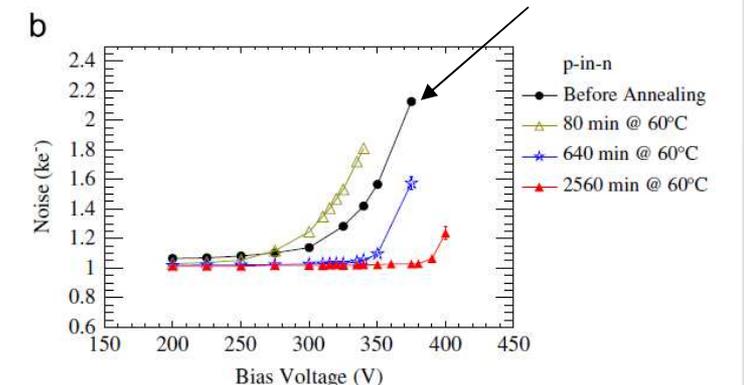
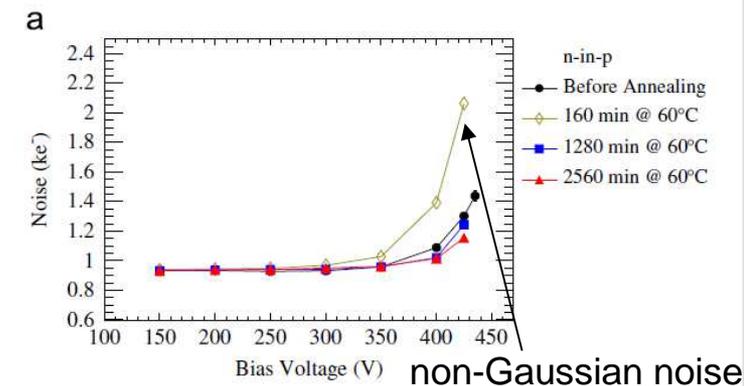
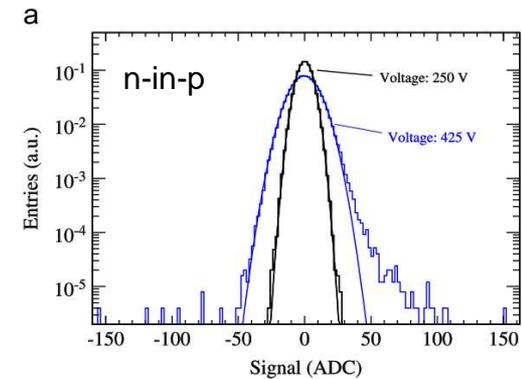
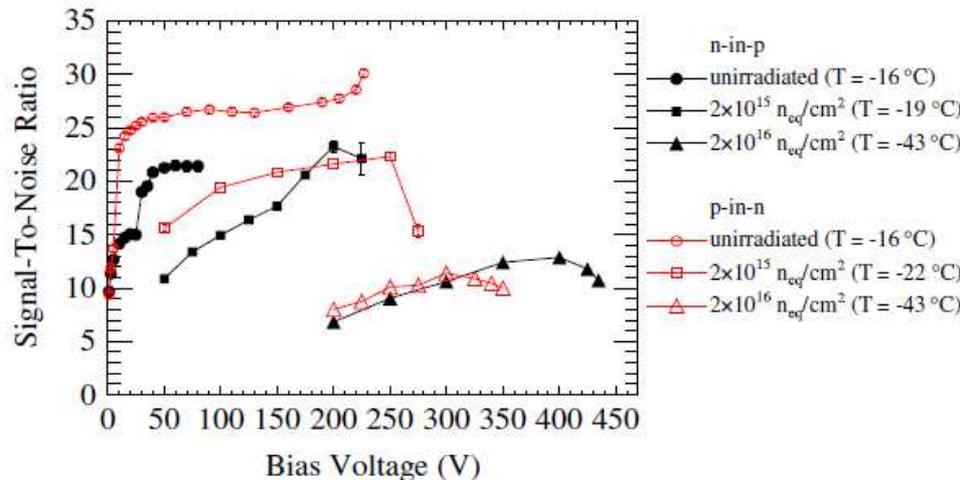


(b) Irradiated to $2 \times 10^{15} n_{eq}/cm^2$, 230 V.

Comparative measurements of highly irradiated n-in-p and p-in-n 3D silicon strip detectors

- M. Köhler, U. Parzefall (Freiburg)
- From conclusions:
 - It could be shown that both designs yield the same signal after the highest irradiation fluence of $2 \times 10^{16} n_{eq}/cm^2$: 15ke- at ~ 400 V (CCE $\sim 70\%$).
 - The noise distribution of the highly irradiated detectors deviates from a Gaussian, when high bias voltages are applied. This effect is possibly caused by micro-discharges.

NIM A 659 (2011): 272–281

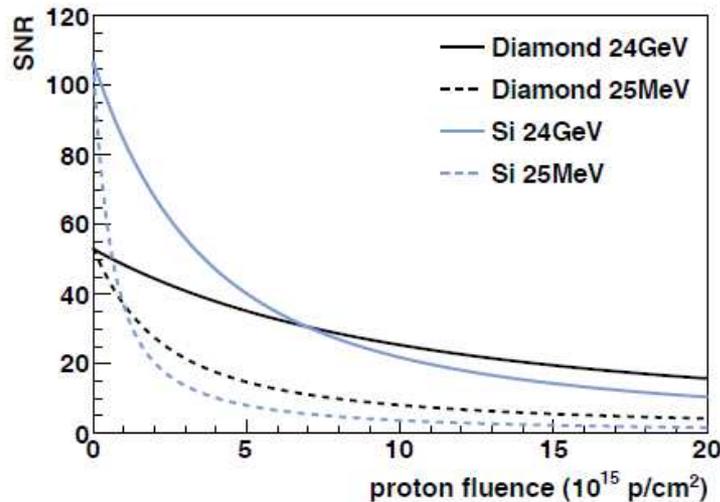


Signal and noise of diamond pixel detectors at high radiation fluences

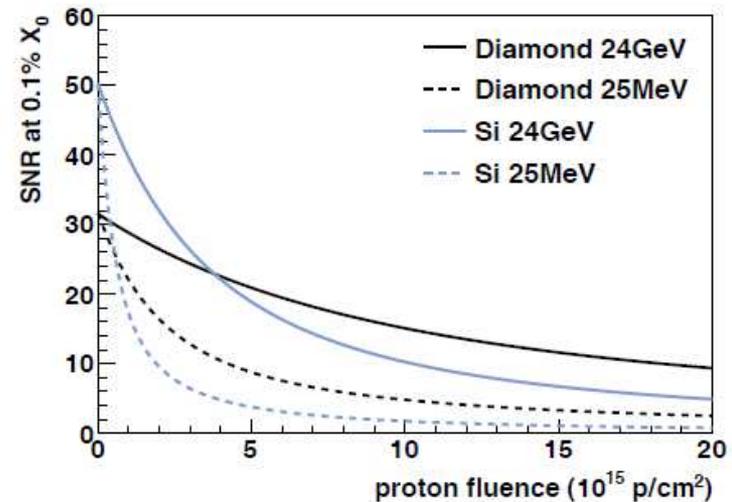
■ J.-W. Tsung, N. Wermes (Bonn)

■ From conclusions:

- The signal development with fluence is extracted from dedicated irradiation campaigns up to fluences of 10^{16} p/cm² at two different energies, 25MeV and 24GeV protons, as well as from published data on silicon.
- The resulting SNR leads to the conclusion that the SNR of diamond pixel sensors exceeds that of planar Si at fluences above several 10^{15} p/cm².

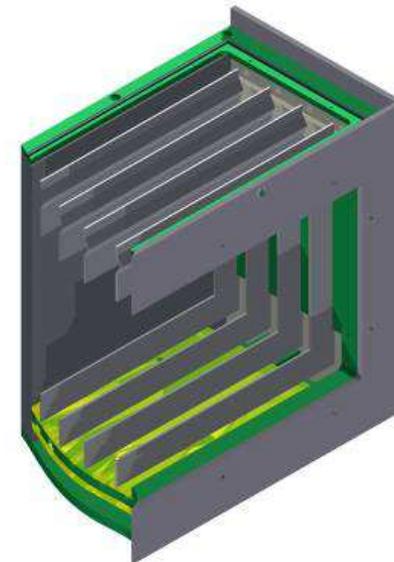
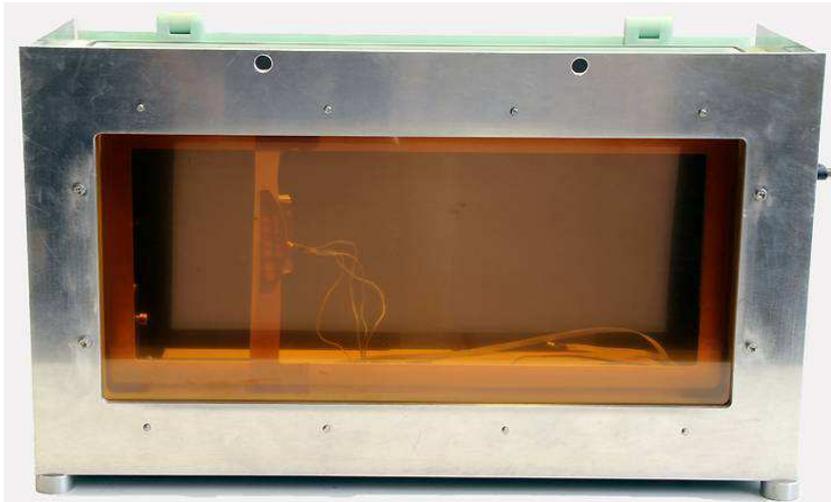


(a) SNR for 200 μ m sensor thickness



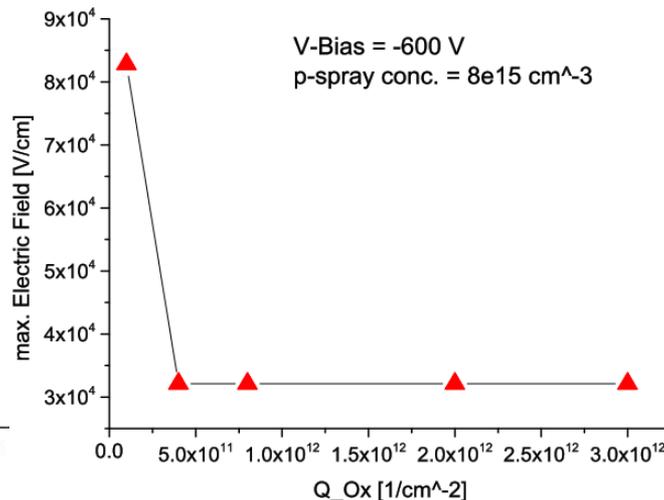
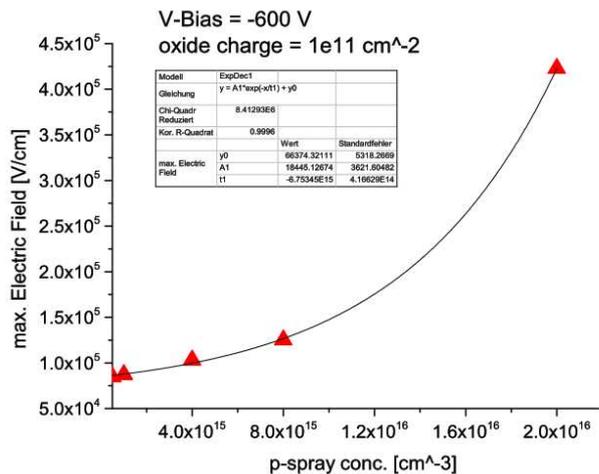
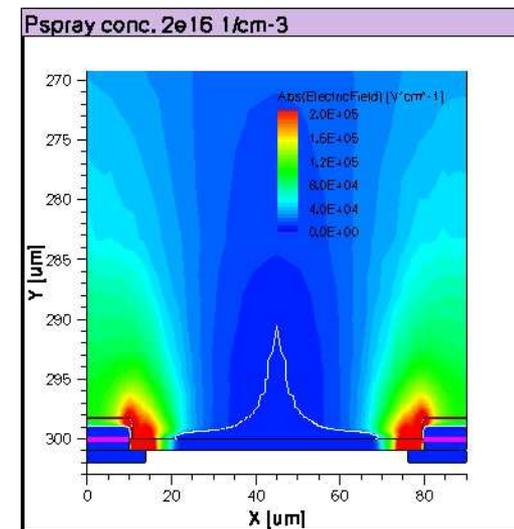
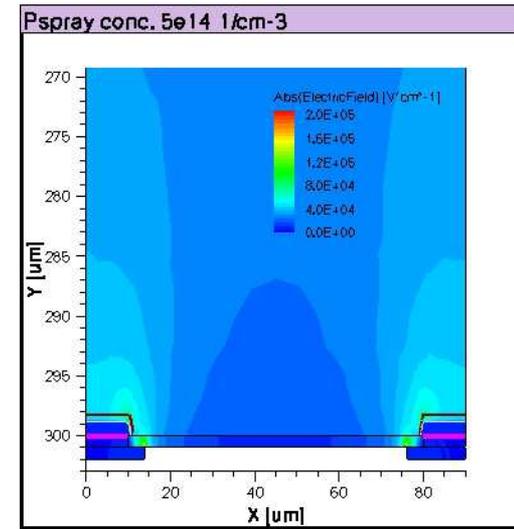
(b) SNR for sensors with 0.1% x/X_0

- Total of 1h proton irradiation for HLL Munich
 - Test of SOI n-in-p sensors on FE-I4 and Parylene coating
- Construction of a new irradiation box allowing up to 4 layers and N₂ flushing to all layers (currently 2 nozzles blowing on target)
- 2 diploma theses profiting from HHA support:
 - S. Frech, *Quantifizierung der Strahlenhärte von Siliziumstreifensensoren aus unterschiedlichen Grundmaterialien*, KIT, 2012, IEKP-KA/2012-021
 - M. Strelzyk, *Design studies of n-in-p silicon strip sensors for the CMS Tracker*, KIT, 2012, IEKP-KA/2012-022



Design studies of n-in-p silicon strip sensors for the CMS Tracker

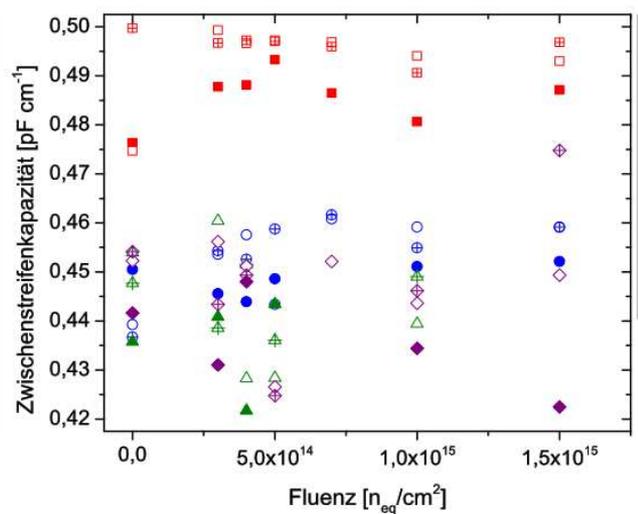
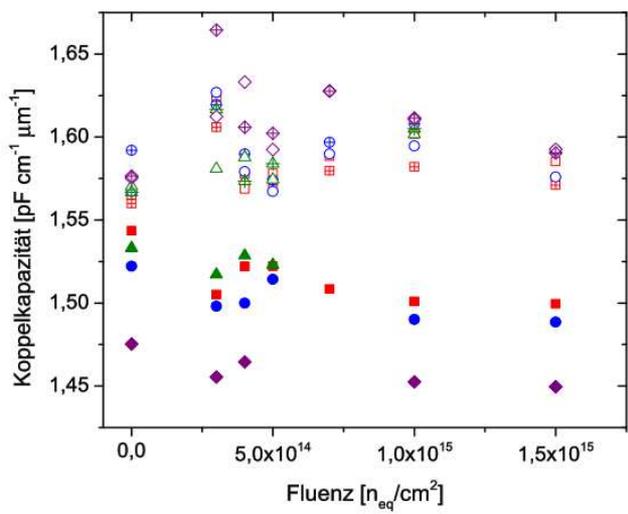
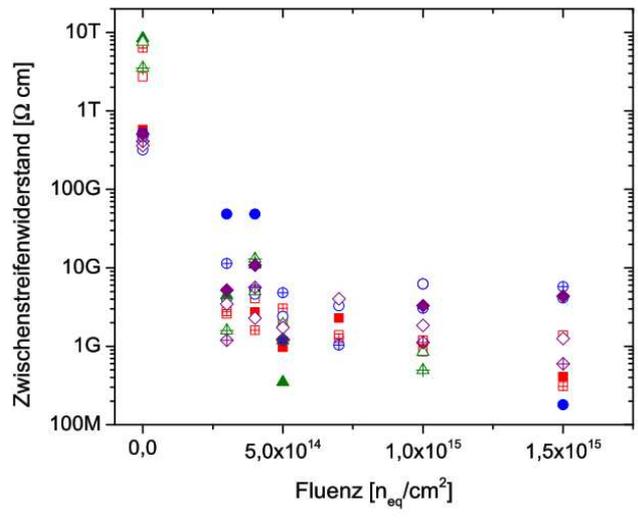
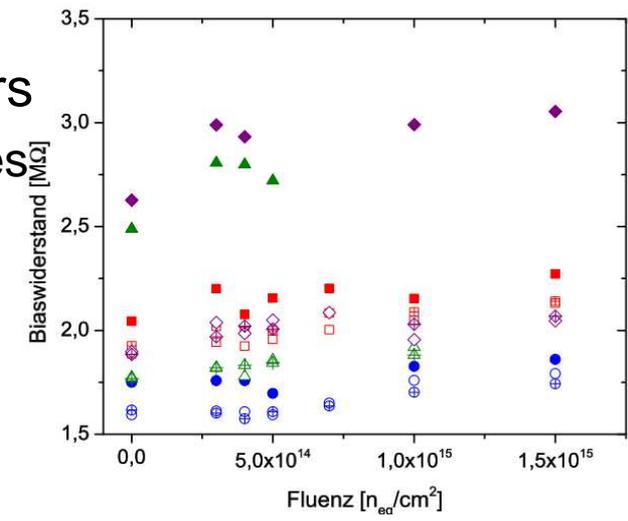
- M. Strelzyk (Karlsruhe)
- E.g.: Strip isolation T-CAD study
 - p-spray technique requires some care to avoid high field break-down before irradiation
 - p-stop works for a wider range of concentrations and should not be placed close to the strip implants



Quantifizierung der Strahlenhärte von Siliziumstreifensensoren aus unterschiedlichen Grundmaterialien

- S. Frech (Karlsruhe)
- E.g.: Strip parameters
 - No severe changes of most strip parameters with irradiation
 - R_{int} drops fast, but settles at high enough values to guarantee strip isolation

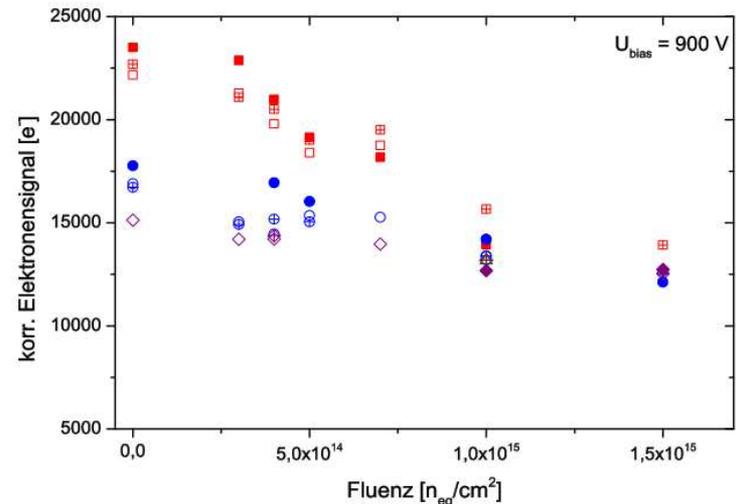
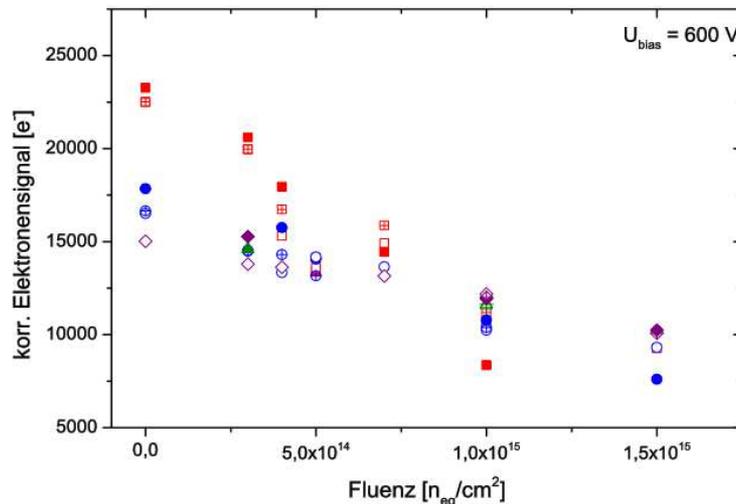
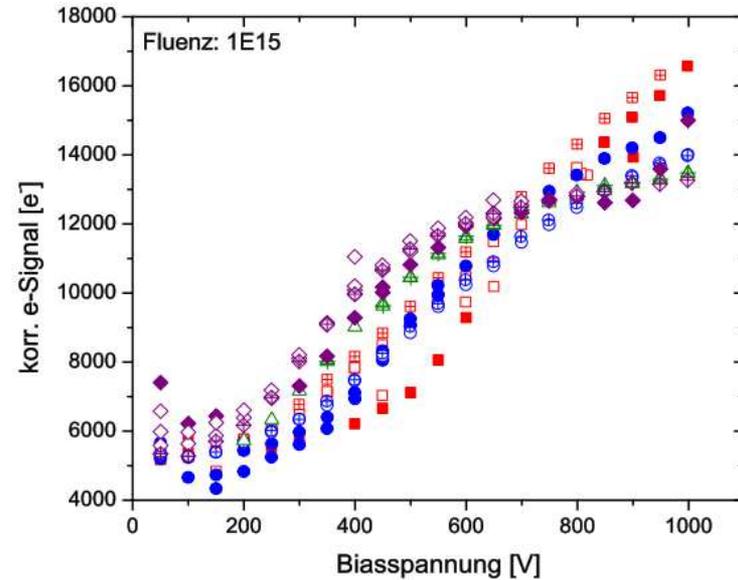
■	FZ320N
□	FZ320P
■	FZ320Y
●	FZ200N
○	FZ200P
⊕	FZ200Y
▲	FTH200N
△	FTH200P
⊕	FTH200Y
◆	MCZ200N
◇	MCZ200P
⊕	MCZ200Y



IEKP-KA/2012-021

Quantifizierung der Strahlenhärte von Siliziumstreifensensoren aus unterschiedlichen Grundmaterialien

- S. Frech (Karlsruhe)
- E.g.: Charge collection
 - Thin sensor materials become superior to standard 320 μm sensor at around $1\text{e}15\text{neq}/\text{cm}^2$ especially for low bias voltages
 - No reasonable signal seen on FZ320N at $1.5\text{e}15\text{n}_{\text{eq}}/\text{cm}^2$ (max. expected fluence for CMS Strip Tracker)



IEKP-KA/2012-021

Conclusion

- Many irradiation studies have been performed with the help of the Alliance funding resulting in several publications (including acknowledgement of Alliance! 😊).
- Due to the participation of many Alliance members this workpackage was successfully run in the sense of the Alliance initiative.

Thank you!

Backup

Proton Irradiation Facility

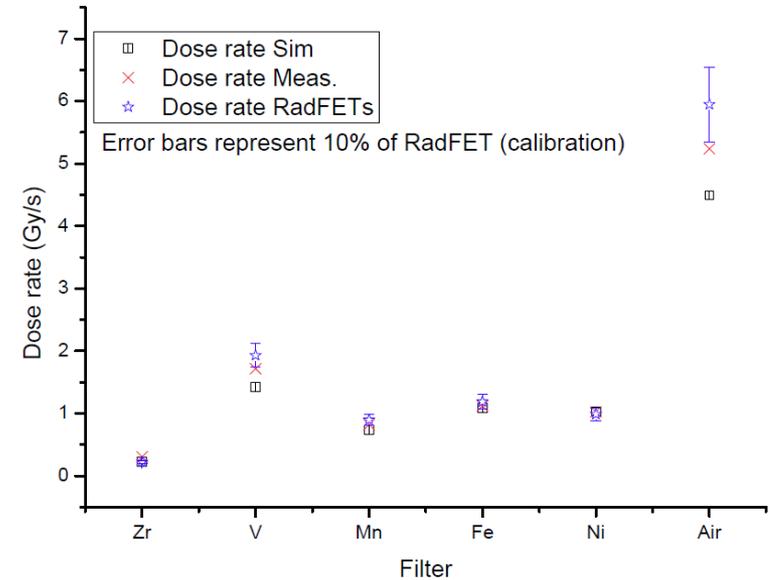
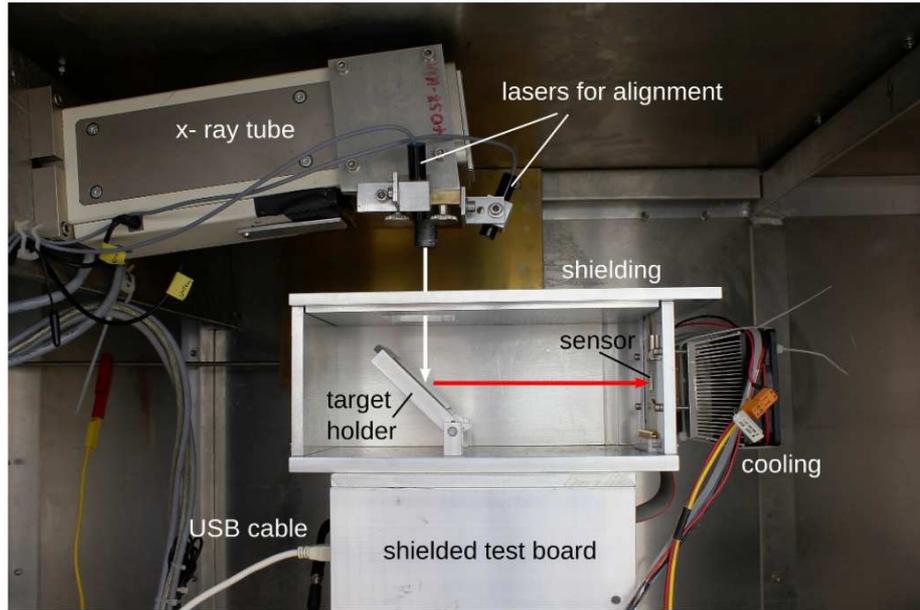


Irradiation box on XY-stage with beam line. Samples are fixed to Al-frames inside the box and scanned to reach uniform exposure.

Proton Energy	~23MeV (25.3MeV at extraction)
Proton Current	~1.5 μ A (100nA - 20 μ A)
Max. Object Width	44cm
Max. Object Height	17cm
N2-Cooling Temp.	$\geq -30^{\circ}$ C
Beam Diameter	~5-10mm



X-Ray Setup



Accelerating Voltage
 Electron Current
 Beam Spot Diameter
 Dose Rate

20-60 kV
 2mA - 33mA (Pmax=2kW)
 1-2cm
 < 18kGy/h
 (depends on distance and filter)

